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July 2015

FDMS86300DC

N-Channel Dual CoolTM 56 PowerTrench[®] MOSFET

80 V, 110 A, 3.1 m Ω

Features

- Dual CoolTM Top Side Cooling PQFN package
- Max $r_{DS(on)}$ = 3.1 m Ω at V_{GS} = 10 V, I_D = 24 A
- Max $r_{DS(on)}$ = 4.0 m Ω at V_{GS} = 8 V, I_D = 21 A
- High performance technology for extremely low r_{DS(on)}
- 100% UIL Tested
- RoHS Compliant

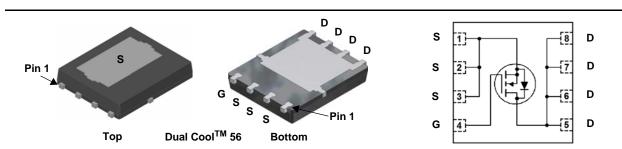


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process. Advancements in both silicon and Dual CoolTM package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance by extremely low Junction-to-Ambient thermal resistance.

Applications

- Synchronous Rectifier for DC/DC Converters
- Telecom Secondary Side Rectification
- High End Server/Workstation Vcore Low Side



MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

Symbol	Param	eter		Ratings	Units
V _{DS}	Drain to Source Voltage			80	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T _C = 25 °C		110	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	24	A
	-Pulsed		(Note 2)	260	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	240	mJ
P _D	Power Dissipation	T _C = 25 °C		125	W
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.2	VV
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Top Source)	2.3	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Bottom Drain)	1.0	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	38	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	81	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1i)	16	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1j)	23	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1k)	11	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86300	FDMS86300DC	Dual Cool TM 56	13"	12 mm	3000 units

FDMS86300DC
N-Channel Dual Cool
Dual
R
56 PowerT
Trench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		45		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
GSS	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.5	3.3	4.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 24 A		2.6	3.1	3.1	
DS(on)		V _{GS} = 8 V, I _D = 21 A		3.1	4.0	mΩ	
()		V _{GS} = 10 V, I _D = 24 A, T _J = 125 °C		4.1	5.0		
ĴFS	Forward Transconductance	V _{DD} = 10 V, I _D = 24 A		79		S	
C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	$V_{\rm DS} = 40 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$		5265 929	7005 1235	pF pF	
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		21	50	pF	
R _g	Gate Resistance		0.1	1.2	2.6	Ω	
	Characteristics			1	1	1	
t _{d(on)}	Turn-On Delay Time			29	47	ns	
r	Rise Time	$V_{DD} = 40 \text{ V}$, $I_{D} = 24 \text{ A}$,		25	44	ns	
d(off)	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		35	57	ns	
f	Fall Time			9	18	ns	
)	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		72	101	nC	
ס _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 40 V$		59	84	nC	
⊋ _{gs}	Total Gate Charge	I _D = 24 A		26		nC	
ସ _{ୁଗ}	Gate to Drain "Miller" Charge			14		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.7 A$ (Note 2)		0.72	1.2	v	
	_	$V_{GS} = 0 V, I_S = 24 A$ (Note 2)		0.80	1.3		
S	Diode continuous forward current	— T _C = 25 °C			75	A	
S pulso	Diode pulse current	0			150		

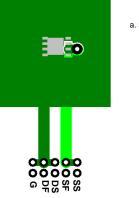
Diode pulse current 150 I_{S, pulse} t_{rr} Reverse Recovery Time 56 88 ns $I_{F} = 24 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ Reverse Recovery Charge 42 67 nC Q_{rr}

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Top Source)	2.3	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Bottom Drain)	1.0	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	38	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	81	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1c)	27	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1d)	34	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1e)	16	0 0 AA/
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1f)	19	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1g)	26	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1h)	61	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1i)	16	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1j)	23	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1k)	11	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1I)	13	

NOTES:

1. R_{0JA} is determined with the device mounted on a FR-4 board using a specified pad of 2 oz copper as shown below. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 38 °C/W when mounted on a 1 in 2 pad of 2 oz copper



b. 81 °C/W when mounted on a minimum pad of 2 oz copper

c. Still air, 20.9x10.4x12.7mm Aluminum Heat Sink, 1 in 2 pad of 2 oz copper

d. Still air, 20.9x10.4x12.7mm Aluminum Heat Sink, minimum pad of 2 oz copper

e. Still air, 45.2x41.4x11.7mm Aavid Thermalloy Part # 10-L41B-11 Heat Sink, 1 in² pad of 2 oz copper

f. Still air, 45.2x41.4x11.7mm Aavid Thermalloy Part # 10-L41B-11 Heat Sink, minimum pad of 2 oz copper

g. 200FPM Airflow, No Heat Sink,1 in² pad of 2 oz copper

h. 200FPM Airflow, No Heat Sink, minimum pad of 2 oz copper

i. 200FPM Airflow, 20.9x10.4x12.7mm Aluminum Heat Sink, 1 in² pad of 2 oz copper

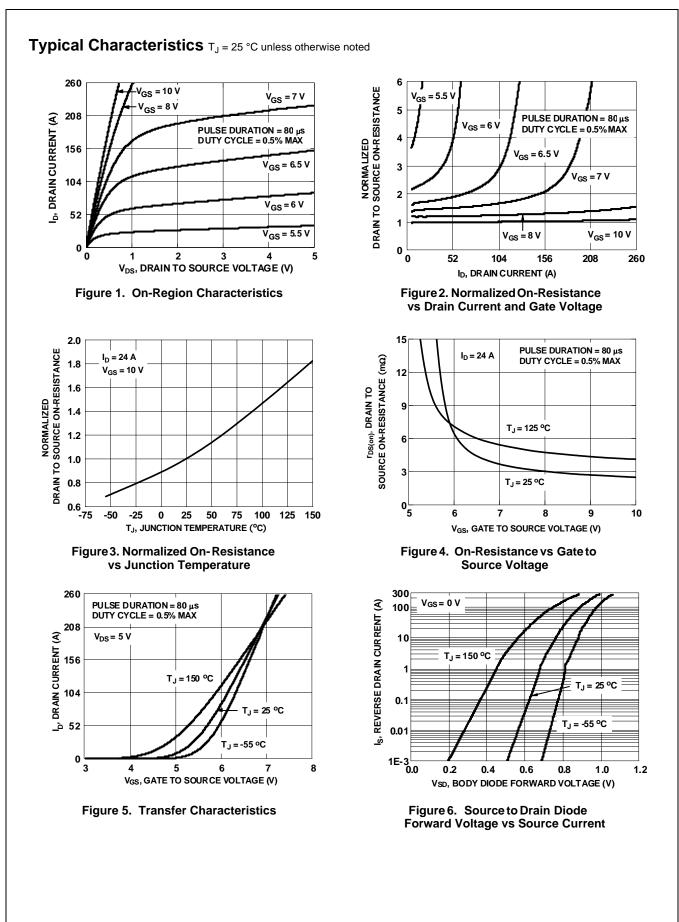
j. 200FPM Airflow, 20.9x10.4x12.7mm Aluminum Heat Sink, minimum pad of 2 oz copper

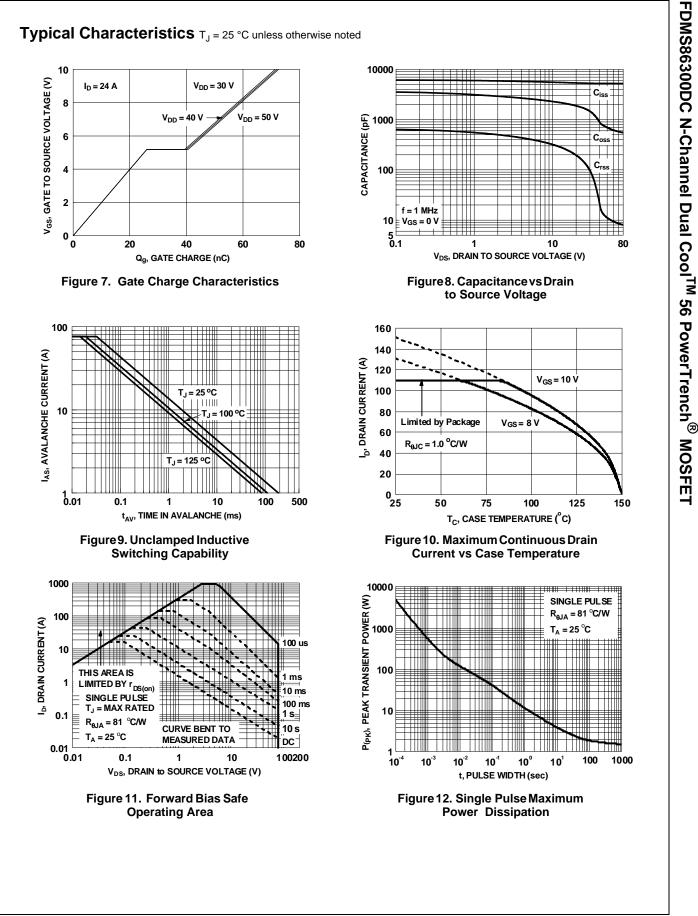
k. 200FPM Airflow, 45.2x41.4x11.7mm Aavid Thermalloy Part # 10-L41B-11 Heat Sink, 1 in² pad of 2 oz copper

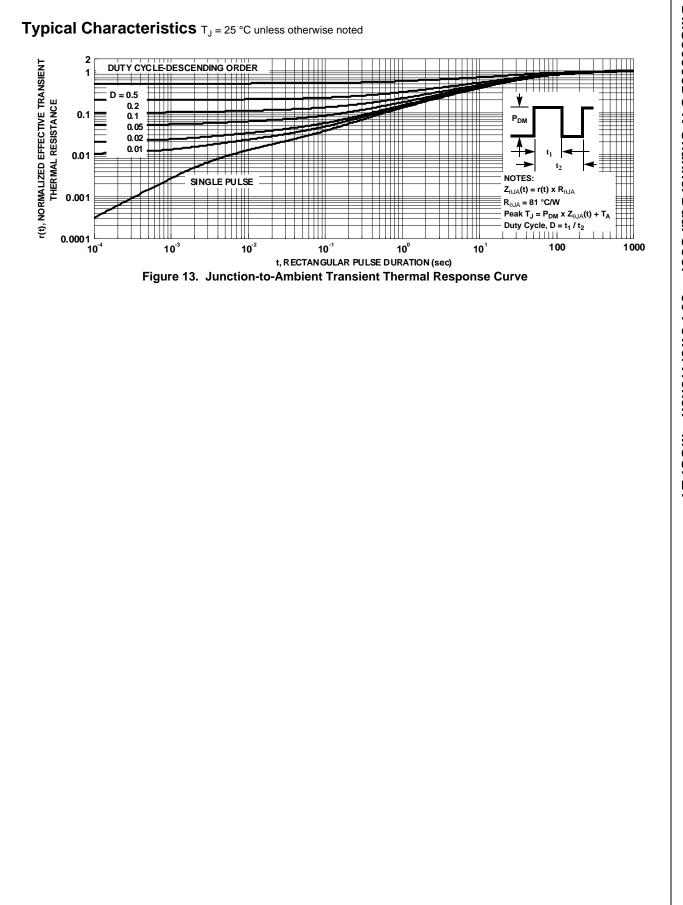
I. 200FPM Airflow, 45.2x41.4x11.7mm Aavid Thermalloy Part # 10-L41B-11 Heat Sink, minimum pad of 2 oz copper

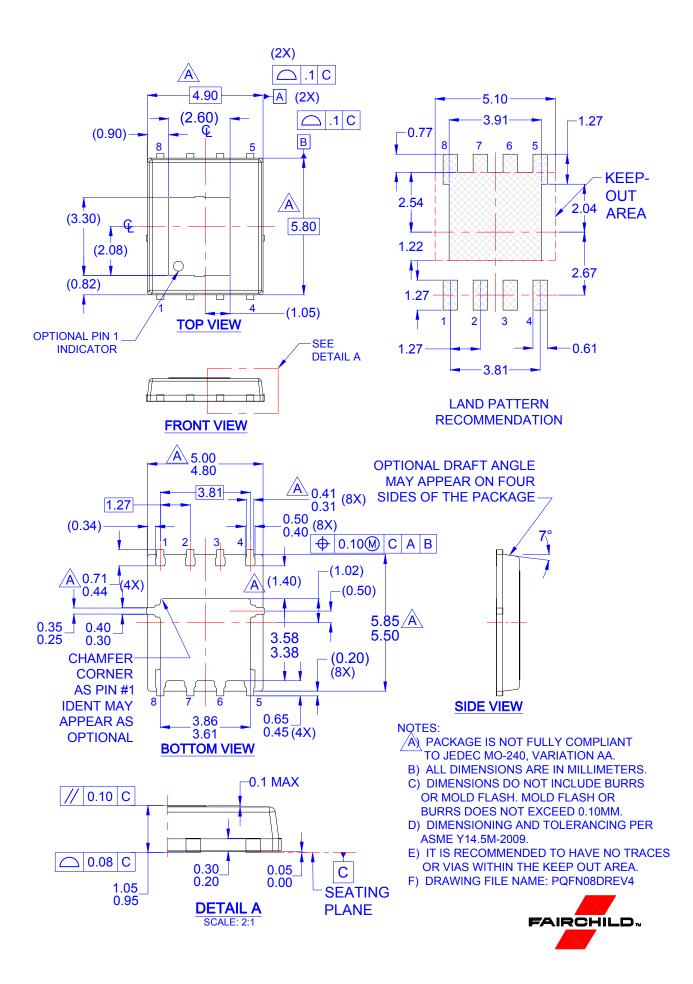
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 $^oC,\,L$ = 0.3 mH, I_{AS} = 40 A, V_{DD} = 72 V, V_{GS} = 10 V.









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